January 2009

FXM2IC102 Dual Supply 2-Bit I²C Interface Voltage Translator with Configurable Voltage Supplies and Signal Levels and Auto-Direction Sensing

Features

- Bi-directional interface between any two levels from 1.65V to 5.5V
- Buffer isolates capacitance and allows 400pF on each port
- Open-drain inputs/outputs
- Accommodates standard-mode and fast-mode l²C-bus devices
- Fully configurable: inputs and outputs track V_{CC} level
- Non-preferential power-up; either V_{CC} may be powered-up first
- Outputs remain in 3-state until active V_{CC} level is reached
- Outputs switch to 3-state if either V_{CC} is at GND
- Power off high impedance
- Active high output enable referenced to V_{CCA} voltage
- 5V tolerant output enable
- Packaged in 8-terminal leadless MicroPak[™] (1.6mm x 1.6mm)
- Direction control not needed
- ESD protection exceeds:
 - 8kV HBM ESD (per JESD22-A114 & Mil Std 883e 3015.7)
 - 15kV HBM I/O to GND ESD (per JESD22-A114 & Mil Std 883e 3015.7)

General Description

The FXM2IC102 is a configurable dual-voltage-supply translator designed for bi-directional voltage translation over a wide range of input and output voltages levels.

The FXM2IC102 is intended for use as a voltage translator in applications using the I²C bus interface. Input and output voltage levels are compatible with I²C device specification voltage levels.

The device is designed so that the A port tracks the V_{CCA} level and the B port tracks the V_{CCB} level. This allows for bi-directional voltage translation over voltage ranges: 1.8V, 2.5V, 3.3V, 5.0V.

The device remains in 3-state until both V_{CC} s reach active levels, allowing either V_{CC} to be powered-up first. Internal power-down control circuits place the device in 3-state if either V_{CC} is removed.

The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

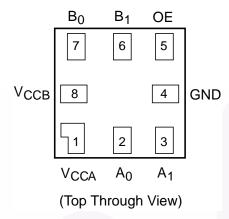
Ordering Information

Order Number	Top Mark	Eco Status	Package Description	Packing Method
FXM2IC102L8X	XG	Green	8-Lead MicroPak, 1.6 mm Wide	3000 Units on Tape and Reel

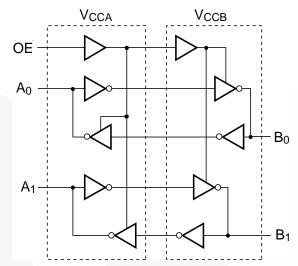


For Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs green.html.

Connection Diagram



Functional Diagram



Pin Description

Pin#	Name	Description
1	V_{CCA}	A-Side Power Supply
2, 3	A ₀ , A ₁	A-Side Inputs or 3-State Outputs
4	GND	Ground
5	OE	Output Enable Input
6, 7	B ₁ , B ₀	B-Side Inputs or 3-State Outputs
8	V_{CCB}	B-Side Power Supply

Function Table

Control	Outnute					
OE	Outputs					
LOW Logic Level	3-State					
HIGH Logic Level	Normal Operation					

Power-Up/Power-Down Sequencing

FXM translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0V, outputs are in a high-impedance state. The control input (OE) is designed to track the V_{CCA} supply. A pull-down resistor tying OE to GND should be used to ensure that bus contention, excessive currents, or oscillations do not occur during power-up/power-down. The size of the pull-down resistor is based upon the current-sinking capability of the device driving the OE pin.

The recommended power-up sequence is the following:

- 1. Apply power to the first V_{CC} .
- 2. Apply power to the second V_{CC} .
- 3. Drive the OE input high to enable the device.

The recommended power-down sequence is the following:

- 1. Drive OE input low to disable the device.
- 2. Remove power from either V_{CC} .
- 3. Remove power from other V_{CC}.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CCA} , V _{CCB}	Supply Voltage	-0.5V to +7.0V
	DC Input Voltage	
V_1	A Port	-0.5V to +7.0V
٧١	B Port	-0.5V to +7.0V
	Control Input (OE)	-0.5V to +7.0V
	Output Voltage ⁽¹⁾	
	A _n Outputs 3-State	-0.5V to +7.0V
Vo	B _n Outputs 3-State	-0.5V to +7.0V
	A _n Outputs Active	–0.5V to V _{CCA} + 0.5V
	B _n Outputs Active	-0.5V to V _{CCB} + 0.5V
I _{IK}	DC Input Diode Current at V _I < 0V	-50mA
	DC Output Diode Current at:	
I _{OK}	V _O < 0V	-50mA
	V _O > V _{CC}	+50mA
I _{OH} /I _{OL}	DC Output Source/Sink Current	-50mA / +50mA
I _{CC}	DC V _{CC} or Ground Current per Supply Pin	±100mA
T _{STG}	Storage Temperature Range	−65°C to +150°C

Note:

1. IO Absolute Maximum Rating must be observed.

Recommended Operating Conditions⁽²⁾

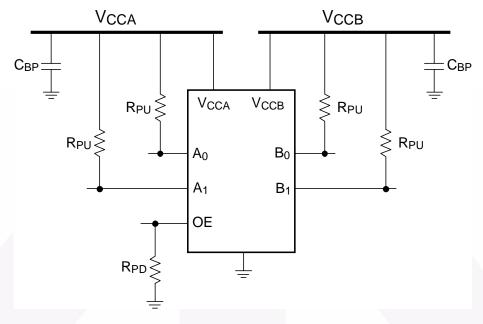
The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CCA} or V _{CCB}	Power Supply Operating	1.65V to 5.5V
	Input Voltage	
V	A Port	0.0V to 5.5V
VI	B Port	0.0V to 5.5V
	Control Input (OE)	0.0V to V _{CCA}
Δt/Δν	Maximum Input Edge Rate V _{CCA/B} = 1.65V to 5.5V	200ns/ V
T _A	Free Air Operating Temperature	-40°C to +85°C

Note:

2. All unused inputs and I/O pins must be held at V_{CCI} or GND.

Application Circuit



Application Notes

The FXM2IC102 has open-drain outputs and requires pull-up resistors on the four data I/O pins, as shown in the above figure. If a pair of data I/O pins (A_n/B_n) are not used, they both should be tied to GND (or both to V_{CC}). In this case, pull-down or pull-up resistors are not required.

The recommended values for the pull-up resistors (R_{PU}) are $1k\Omega$ minimum to $10k\Omega$ maximum. The recommended value for the bypass capacitors (C_{BP}) is $0.1\mu F$. The recommended value for the pull-down resistor (R_{PD}) on OE is $1k\Omega$ or higher and may depend upon the current-sinking capability of the device driving the OE pin.

DC Electrical Characteristics

 $T_A = -40$ °C to +85°C.

Symbol	Parameter	V _{CCA} (V)	٧٥	CCB (V)	C	onditions	Min.	Max.	Units	
V _{IHA}		1.65-5.50	1.	65–5.50	Data Inp	uts A _n	0.7 x V _{CCA}		V	
	High Level Input Voltage	1.65-5.50	1.	65–5.50	Control I	nput OE	0.9 x V _{CCA}		V	
V _{IHB}	voltage	1.65-5.50	1.	65–5.50	Data Inp	uts B _n	0.7 x V _{CCB}		V	
V		1.65-5.50	1.	65–5.50	Data Inp	uts A _n		0.3 x V _{CCA}	V	
V_{ILA}	Low Level Input Voltage	1.65-5.50	1.	65–5.50	Control I	nput OE		0.1 x V _{CCA}	V	
V _{ILB}	vollago	1.65-5.50	1.	65–5.50	Data Inp	uts B _n		0.3 x V _{CCB}	V	
M		1.65-2.30	1.	65–5.50	I _{OL} = 3mA			0.1 x V _{CCA}	V	
V _{OLA}	Low Level	3.00-5.50	1.	65–5.50	A Port	I _{OL} = 6mA		0.2	ľ	
M	Output Voltage ⁽³⁾	1.65-5.50	1.	65–2.30	B Port	I _{OL} = 3mA		0.1 x V _{CCB}	V	
V _{OLB}		1.65-5.50	3.	00–5.50	BPOIL	I _{OL} = 6mA		0.2	ľ	
I _I	Input Leakage Current	1.65–5.50	1.	65–5.50		Control input OE, V _I = V _{CCA} or GND		±1.0	μA	
. /	Power Off Leakage	0		5.50	A _n	V_I or $V_O = 0V$ to 5.5V		±2.0	4	
OFF	Current	5.50		0	B _n	V_I or $V_O = 0V$ to 5.5V		±2.0	μA	
		5.50		5.50	A _n , B _n	$V_O = 0V$ to 5.5V, OE = V_{IL}		±2.0		
I _{OZ}	3-State Output Leakage ⁽⁴⁾	5.50		0	A _n	$V_O = 0V$ to 5.5V, OE = Don't Care		±2.0	μA	
		0		5.50	B _n	$V_O = 0V$ to 5.5V, OE = Don't Care		±2.0		
I _{CCA/B}	Quiescent Supply Current ⁽⁵⁾⁽⁶⁾	1.65–5.50	1.	65–5.50	$V_I = V_{CC}$	or GND, I _O = 0		5.0	μA	
I _{CCZ}	Quiescent Supply Current ⁽⁵⁾	1.65–5.50	1.	65–5.50	$V_I = V_{CC}$ $OE = V_{II}$	or GND, I _O = 0,		5.0	μA	
	Quiescent Supply	0	1.	65–5.50	$V_1 = 5.5 \text{V or GND}, I_0 = 0,$			-2.0		
I _{CCA}	Current	1.65-5.50		0	OE = Don't Care, B_n to A_n			2.0	μA	
	Quiescent Supply	1.65-5.50		0	V _I = 5.5	/ or GND, I _O = 0,		-2.0	μА	
I _{CCB}	Current	0	1.	65–5.50		on't Care, A _n to B _n	/	2.0		

Notes:

- 3. This is the output voltage for static conditions. Dynamic drive specifications are given in "Dynamic Output Electrical Characteristics" table.
- 4. "Don't Care" indicates any valid logic level.
- 5. V_{CCI} is the V_{CC} associated with the input side.
- 6. Reflects current per supply, V_{CCA} or V_{CCB} .

Dynamic Output Electrical Characteristics

Output Rise/Fall Time and Dynamic Output Current⁽⁷⁾

Output Load: $C_L = 50pF$, $R_L = 1k\Omega$.

	Parameter	T _A = -40°C to +85°C, V _{CCO} ⁽⁸⁾ =									
Symbol		4.5V to 5.5V		3.0V t	3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		
		Тур.	Max.	Тур.	Max.	Тур.	Max.	Тур.	Max.		
t _{rise}	Output Rise Time, A Port, B Port ⁽⁹⁾		4		5		6		8	ns	
t _{fall}	Output Fall Time, A Port, B Port ⁽¹⁰⁾		4		5		6		8	ns	
I _{OHD}	Dynamic Output Current HIGH ⁽⁹⁾	-45		-24		-15		-8		mA	
I _{OLD}	Dynamic Output Current LOW ⁽¹⁰⁾	+45		+24		+15		+8		mA	

Maximum Data Rate⁽¹¹⁾

Output Load: $C_L = 50pF$, $R_L = 1k\Omega$.

		$T_A = -40$ °C to +85°C, $V_{CCB} =$								
V _{CCA} =	4.5V to 5.5V	3.0V to 3.6V	2.3V to 2.7V	1.65V to 1.95V	Units					
	Min.	Min.	Min.	Min.						
4.5V to 5.5V	40	35	30	20	MHz					
3.0V to 3.6V	35	35	30	20	MHz					
2.3V to 2.7V	30	30	25	20	MHz					
1.65V to 1.95V	20	20	20	20	MHz					

Notes:

- 7. Dynamic output characteristics are guaranteed, but not tested.
- 8. V_{CCO} is the V_{CC} associated with the output side.
- 9. See Figure 5.
- 10. See Figure 6.
- 11. Maximum data rate is guaranteed, but not tested.

AC Characteristics

Output Load: $C_L = 50pF$, $R_L = 1k\Omega$.

V_{CCA} = 4.5V to 5.5V

				T _A	= -40°C	to +85°C,	V _{CCB} =			
Symbol	Parameter	4.5V to 5.5V		3.0V t	3.0V to 3.6V		2.3V to 2.7V		o 1.95V	Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	1
+	A to B	1.0	4.5	1.5	5.5	2.0	7.0	3.0	11.5	- ns
t _{PLH}	B to A	1.0	4.5	1.5	5.5	1.5	6.5	2.5	9.5	
+	A to B	2.0	6.0	2.5	6.5	3.0	8.0	4.0	12.5	- ns
t _{PHL}	B to A	2.0	6.0	2.5	7.0	3.0	8.0	3.5	12.0	
+	OE to A		9.5		10.0		11.5		18.0	ns
t _{PZL}	OE to B		9.0		11.0		13.5		22.0	
t	OE to A		26.5		26.5		26.5		26.5	1
t _{PLZ}	OE to B		26.0		26.5		20.5		15.5	ns
t _{skew}	A Port, B Port ⁽¹²⁾		0.5		0.5		0.5		0.5	ns

$V_{CCA} = 3.0V \text{ to } 3.6V$

	Parameter			T _A	= -40°C	to +85°C,	V _{CCB} =	1		
Symbol		4.5V to 5.5V		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{PLH}	A to B	1.5	5.5	1.5	6.5	2.0	8.0	3.0	12.0	200
	B to A	1.5	5.5	1.5	6.5	2.0	7.5	2.5	10.5	ns
4	A to B	2.5	7.0	2.5	7.5	3.0	9.0	4.0	13.0	- ns
t _{PHL}	B to A	2.5	6.5	2.5	7.5	3.0	9.5	4.0	13.0	
+	OE to A		12.5		13.0		15.5		21.0	ne
t _{PZL}	OE to B		10.0		12.5		14.5		22.5	ns
+	OE to A		27.5		28.0		28.0		28.0	ns
	OE to B		27.5		28.0		28.5		22.5	115
t _{skew}	A Port, B Port ⁽¹²⁾		0.5		0.5		0.5		0.5	ns

$V_{CCA} = 2.3V \text{ to } 2.7V$

OOA											
		$T_A = -40$ °C to $+85$ °C, $V_{CCB} =$									
Symbol	Parameter	4.5V to 5.5V		3.0V t	3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
	A to B	1.5	6.5	2.0	7.5	2.5	8.5	3.5	12.5		
t _{PLH}	B to A	2.0	7.5	2.0	8.0	2.5	8.5	3.0	11.5	ns	
	A to B	3.0	8.5	3.0	9.5	3.0	10.0	4.0	13.5	ns	
t _{PHL}	B to A	3.0	8.0	3.0	9.0	3.0	10.0	4.5	14.0		
+	OE to A		16.0		16.5		18.0		23.5	no	
t_{PZL}	OE to B		11.0		14.0		15.5		23.5	ns	
+	OE to A		29.0		29.0		29.5		29.5	ns	
t _{PLZ}	OE to B		29.0		29.0		29.5		29.5	113	
t _{skew}	A Port, B Port ⁽¹²⁾		0.5		0.5		0.5		0.5	ns	

AC Characteristics (Continued)

Output Load: $C_L = 50pF$, $R_L = 1k\Omega$.

 $V_{CCA} = 1.65V \text{ to } 1.95V$

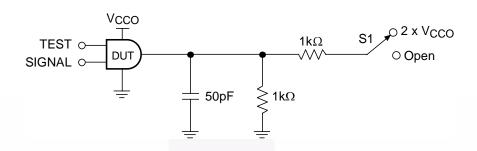
				T _A	= -40°C	to +85°C,	V _{CCB} =			
Symbol	Parameter	4.5V to 5.5V		3.0V to 3.6V		2.3V to 2.7V		1.65V to 1.95V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{PLH}	A to B	2.5	9.5	2.5	10.5	3.0	11.5	4.0	15.0	no
	B to A	3.0	11.5	3.0	12.0	3.5	12.5	4.0	15.0	ns
4	A to B	3.5	11.5	4.0	12.5	4.5	14.0	5.0	15.5	- ns
t _{PHL}	B to A	4.0	12.5	4.0	13.0	4.0	13.5	5.0	15.5	
+	OE to A		27.0		27.0		27.0		30.0	ns
t _{PZL}	OE to B		18.0		19.5		22.5		29.0	
t	OE to A		34.0		34.0		34.5		35.0	
t _{PLZ}	OE to B		31.5		32.5		33.5		36.5	- ns
t _{skew}	A Port, B Port ⁽¹²⁾		0.5		0.5		0.5		0.5	ns

Note:

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW). See Figure 8. Skew is guaranteed, but not tested.

Capacitance

Symbol	Parameter	Conditions	T _A = +25°C	Units	
		Conditions	Typical	Offics	
C _{IN}	Input Capacitance Control Pin (OE)	$V_{CCA} = V_{CCB} = GND$	4	pF	
C _{I/O}	Input/Output Capacitance, A _n , B _n	$V_{CCA} = V_{CCB} = 5.0V$, OE = V_{CCA}	6	pF	
C _{PD}	Power Dissipation Capacitance	$V_{CCA} = V_{CCB} = 5.0V,$ $V_{I} = 0V \text{ or } V_{CC}, f = 10MHz$	40	pF	

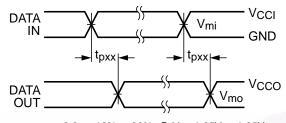


Test	Input Signal	Output Enable Control	S1 Position
t _{PLH} , t _{PHL}	Data Pulses	V _{CCA}	Open
t_{PZL} (OE to A_n , B_n)	0V	LOW to HIGH Switch	2 x V _{CCO}
t_{PLZ} (OE to A_n , B_n)	0V	HIGH to LOW Switch	2 x V _{CCO}

AC Load Table

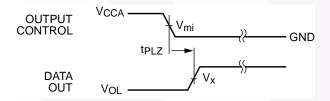
V _{CCO}	CI	RI
1.8V ± 0.15V	50pF	1kΩ
$2.5V \pm 0.2V$	50pF	1kΩ
$3.3V \pm 0.3V$	50pF	1kΩ
5.0V ± 0.5V	50pF	1kΩ

Figure 1. AC Test Circuit and AC Load Table



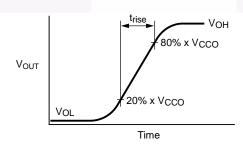
Input $t_R = t_F = 2.0$ ns, 10% to 90% @ $V_I = 1.65$ V to 1.95V Input $t_R = t_F = 2.0$ ns, 10% to 90% @ $V_I = 2.3$ to 2.7V Input $t_R = t_F = 2.5$ ns, 10% to 90%, @ $V_I = 3.0$ V to 3.6V only Input $t_R = t_F = 2.5$ ns, 10% to 90%, @ $V_I = 4.5$ V to 5.5 only

Figure 2. Waveform for Inverting and Non-inverting Functions



$$\begin{split} &\text{Input } t_R = t_F = 2.0 \text{ns}, \ 10\% \ to \ 90\% \ @\ V_I = 1.65 \text{V to } 1.95 \text{V} \\ &\text{Input } t_R = t_F = 2.0 \text{ns}, \ 10\% \ to \ 90\% \ @\ V_I = 2.3 \ to \ 2.7 \text{V} \\ &\text{Input } t_R = t_F = 2.5 \text{ns}, \ 10\% \ to \ 90\%, \ @\ V_I = 3.0 \text{V to } 3.6 \text{V only} \\ &\text{Input } t_R = t_F = 2.5 \text{ns}, \ 10\% \ to \ 90\%, \ @\ V_I = 4.5 \text{V to } 5.5 \ only \end{split}$$

Figure 4. 3-STATE Output High Enable Time



 $I_{OHD} \approx (C_{L} + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_{L} + C_{I/O}) \times \frac{(20\% - 80\%) \times V_{CCO}}{t_{RISF}}$

Figure 5. Active Output Rise Time and Dynamic Output Current High

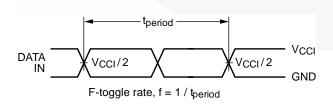
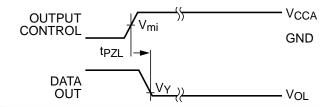


Figure 7. Maximum Data Rate (or F-toggle) in MHz



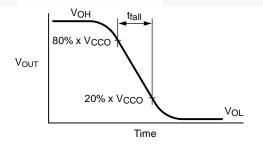
Input $t_R = t_F = 2.0$ ns, 10% to 90% @ $V_I = 1.65$ V to 1.95V Input $t_R = t_F = 2.0$ ns, 10% to 90% @ $V_I = 2.3$ to 2.7V Input $t_R = t_F = 2.5$ ns, 10% to 90%, @ $V_I = 3.0$ V to 3.6V only Input $t_R = t_F = 2.5$ ns, 10% to 90%, @ $V_I = 4.5$ V to 5.5 only

Figure 3. 3-STATE Output Low Enable Time

Symbol	Vcc
V _{mi} ⁽¹³⁾	V _{CCI} / 2
V _{mo}	V _{CCO} / 2
V _X	0.5 x V _{CCO}
V_{Y}	0.1 x V _{CCO}

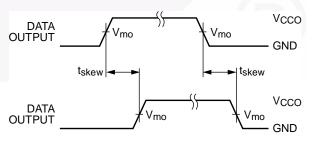
Note:

13. $V_{CCI} = V_{CCA}$ for control pin OE or $V_{mi} = (V_{CCA} / 2)$.



 $I_{OLD} \approx \, \left(C_{L} + C_{I/O}\right) \, x \, \frac{\Delta V_{OUT}}{\Delta t} = \left(C_{L} + C_{I/O}\right) \, x \, \frac{\left(80\% - 20\%\right) \, x \, V_{CCC}}{t_{FALL}}$

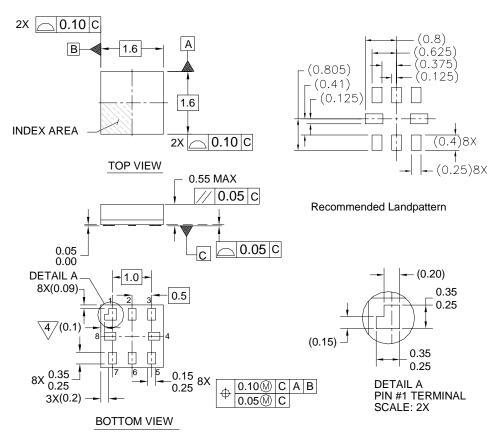
Figure 6. Active Output Fall Time and Dynamic Output Current Low



tskew = (tpHLmax - tpHLmin) or (tpLHmax - tpLHmin)

Figure 8. Output Skew Time

Physical Dimensions



Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET
- 5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

Figure 9. 8-Lead MicroPak, 1.6 mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/packaging/.

Tape & Reel Format for MicroPak™

Always visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
	Leader (Start End)	125 (typical)	Empty	Sealed
L8X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typical)	Empty	Sealed





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™

Current Transfer Logic™ EcoSPARK® EfficentMax™ EZSWTCH™ *

Fairchild®

Fairchild Semiconductor® FACT Quiet Series™ FACT®

FACT®
FAST®
FastvCore™
FlashWriter®*
FPS™
F-PFS™

FRFET®
Global Power ResourceSM
Green FPS™

Green FPS™ e-Series™
GTO™

IntelliMAX™
ISOPLANAR™
MegaBuck™
MICROCOUPLER™

MicroFET™
MicroPak™
MillerDrive™
MotionMax™
Motion-SPM™
OPTOLOGIC®
OPTOLANAR®

PDP SPM™
Power-SPM™
PowerTrench®
PowerXS™

Programmable Active Droop™

QFĒT[®] QS™ Quiet Series™ RapidConfigure™

○_™

Saving our world, 1mVV/VV/kVV at a time™

SmartMaxTM
SMART STARTTM
SPM®
STEALTHTM
SuperFETTM
SuperSOTTM3
SuperSOTTM6
SuperSOTTM8

The Power Franchise®

p wer

TinyBoost™
TinyBuck™
TinyLogic®
TinyPOPTO™
TinyPower™
TinyPWM™
TinyWire™
TriFault Detect™
µSerDes™

SerDes
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
XS™

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS, THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 138